

POSITIVE WORKING PHOTSENSITIVE COMPOSITION

A positive working photosensitive composition comprising an epoxy compound having two or more epoxy groups in one molecule, a curing catalyst or a compound for producing a curing catalyst by heat, and sulfonates, a method of manufacturing a member for a semiconductor comprising the steps of applying the positive working photosensitive composition on a substrate to expose, curing an unexposed part by heat, and developing an exposed part, and a method of manufacturing a member for a display comprising the steps of applying the positive working photosensitive composition on a substrate to expose, curing an unexposed part by heat, and developing an exposed part.